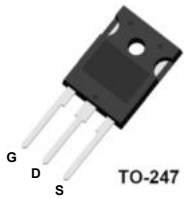
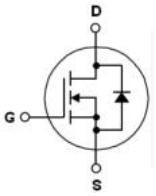
1200V 80mΩ N-Channel SiC Power MOSFET

Description

The AKCQH080N120 is a high blocking voltage N-Channel SiC power MOSFET.
This device provide excellent performance for high voltage power supplies or pulse circuits.





Features

- Typical on-Resistance: $R_{DS\ (on)}$=80mΩ(typ.)
- High Blocking Voltage
- 100% Avalanche Test
- Good Stability and Uniformity with High E_{AS}

Applications

- Solar Inverters
- High Voltage DC/DC Converters
- Motor Drivers
- Switch Mode Power Supplies

Absolute Maximum Ratings @T_C=25 ℃ unless otherwise noted

Symbol	Parameter		Ratings	Unit
V_{DSS}	Drain to Source Voltage		1200	V
V_{GSS}	Gate to Source Voltage		-10/+25	V
V_{GSop}	Recommended operation Values of Gate −Source Voltage		-5/+20	V
I_D	Drain Current	T_C=25℃	36	A
		T_C=100℃	24	A
I_{DM}	Pulsed Drain Current (Note1)		120	A
P_D	Maximum Power Dissipation	T_C=25℃	250	W
	Derate above 25℃		1.67	W/℃
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		300	mJ
T_J	Operating Junction Temperature Range		-50~+175	℃
T_{STG}	Storage Temperature Range		-50~+175	℃

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th\ (J-C)}$	Thermal Resistance, Junction to case	0.6	℃/W
$R_{th\ (J-A)}$	Thermal Resistance, Junction to Ambient	40	℃/W

Electrical Characteristics @T_C=25 ℃ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS}=0V, I_D=100uA	1200	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=5mA	2.0	2.4	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS}=20V, I_D=20A	-	80	120	mΩ
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=1200V, V_{GS}=0V	-	-	100	uA
I_{GSS}	Gate to Source Leakage Current	V_{GS}=25, V_{DS}=0V	-	-	±250	nA

D-S Diode Characteristics and Maximum Rating @T_C=25 ℃ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS}=0V, I_S=10A	-	3.6	5	V
t_{rr}	Reverse Recovery Time	V_{GS}=0V, I_S=20A, di/dt=-290A/us	-	35	-	ns
Q_{rr}	Reverse Recovery Charge		-	91	-	nC

Switching Characteristics @T_C=25 ℃ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	I_D=20A , V_{DD}=800V, R_G=2.5Ω V_{GS} = −5/20V, (Note 3)	-	9.3	-	ns
t_r	Turn-on Rise Time		-	9.5	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	18	-	ns
t_f	Turn-off Fall Time		-	7.6	-	ns
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=1000V, f=1.0MHz	-	1475	-	pF
C_{oss}	Output Capacitance		-	94	-	pF
C_{rss}	Reverse Transfer Capacitance		-	11	-	pF
Q_g	Total Gate Charge	I_D=20A, V_{DD}=800V V_{GS}=-5V/20V (Note 3)	-	79	-	nC
Q_{ge}	Gate to Source Charge		-	24	-	nC
Q_{gd}	Gate to Drain Charge		-	15	-	nC

Note:

1. Repetitive rating: pulse-width limited by maximum junction temperature
2. V_{DD}=100V, L=1mH, V_{clamp}=1600V, V_G=10V, I_D=19.0A
3. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Fig. 1. Typical on-Resistance Characteristics

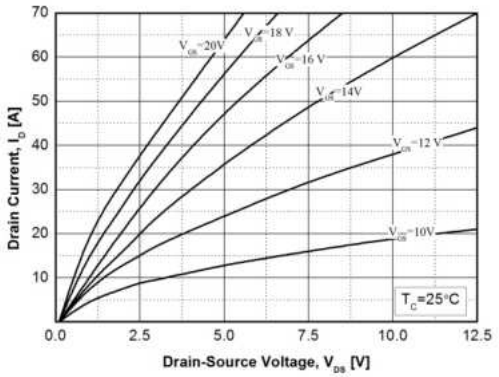


Fig. 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

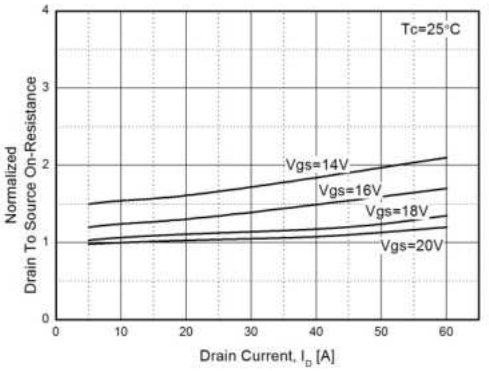


Fig. 3. Normalized On-Resistance vs. Junction Temperature

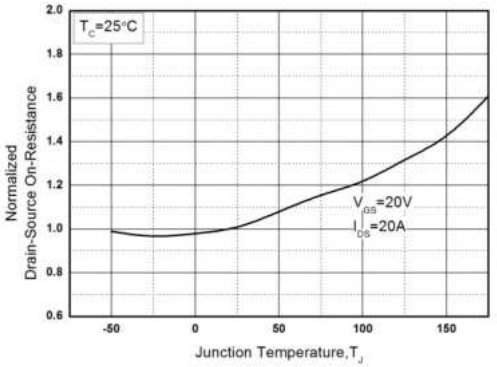


Fig. 4. On-Resistance vs. Gate-to-source Voltage

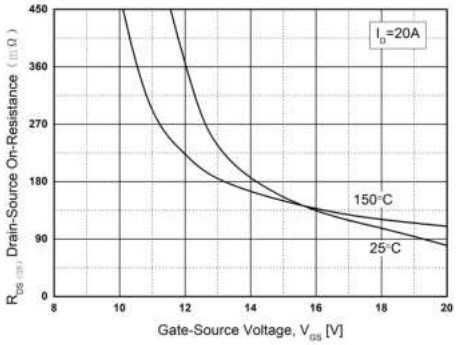


Fig. 5. Transfer Characteristics

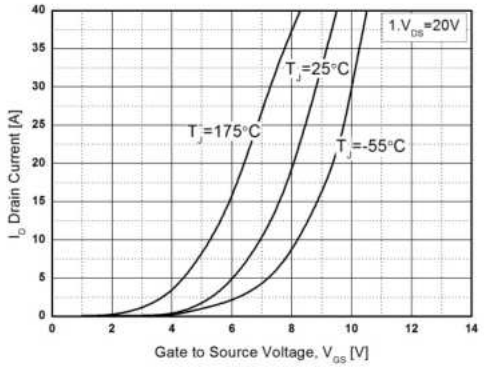
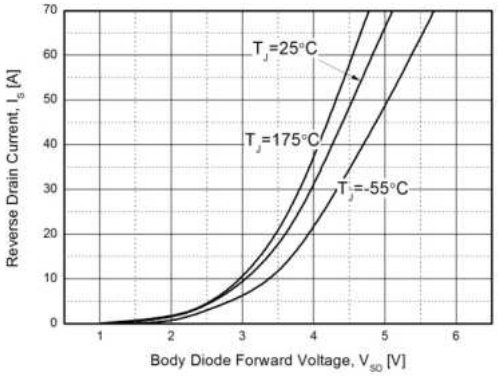


Fig. 6. Source-to-Drain Diode Forward Voltage vs. Source Current



Typical Performance Characteristics

Fig. 7. Gate Charge Characteristics

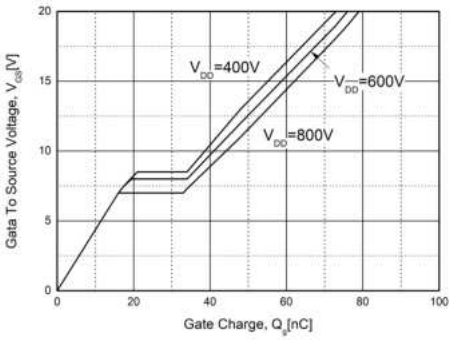


Fig. 8. Characteristics vs. Drain-to-Source Voltage

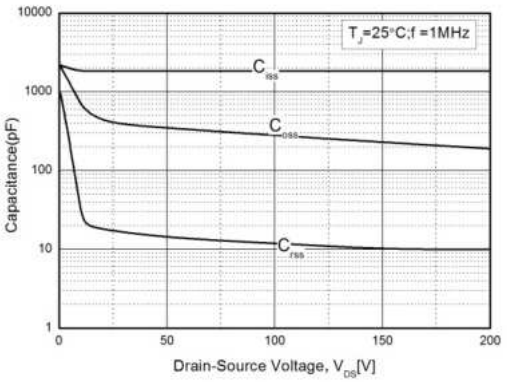
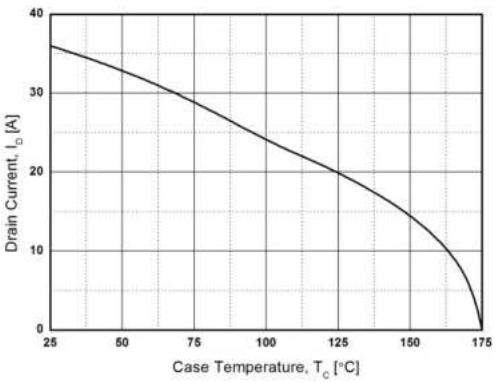


Fig. 9. Maximum Drain Current vs. Temperature



Package Dimensions

TO-247

(Dimensions in Millimeters)